



GP
ELECTRONICS

GP3002SM
30V N-Channel MOSFET

Product Summary

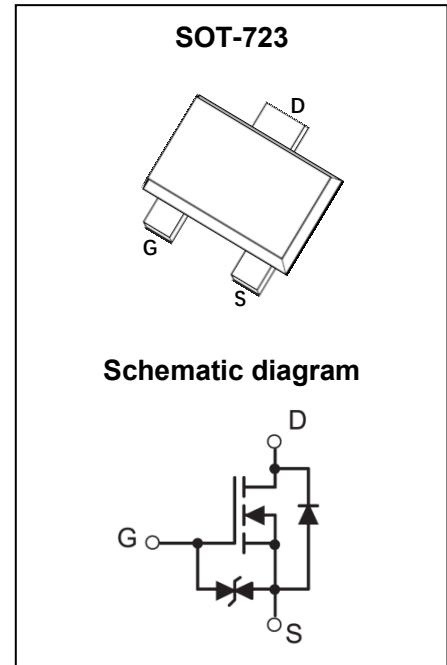
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
30V	0.92Ω@10V	0.3A
	0.98Ω@4.5V	
	1.0Ω@4.0V	
	1.2Ω@2.5V	

Feature

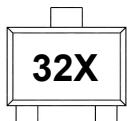
- Trench Technology Power MOSFET
- Low $R_{DS(ON)}$
- Low Gate Charge
- ESD Protected

Application

- Interfacing, Switching



MARKING:



X: date code

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	30	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^{1,5}	I_D	0.3	A
Pulsed Drain Current ²	I_{DM}	1.2	A
Power Dissipation ^{4,5}	P_D	0.45	W
Thermal Resistance from Junction to Ambient ⁵	$R_{\theta JA}$	278	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{STG}	-55~+150	°C

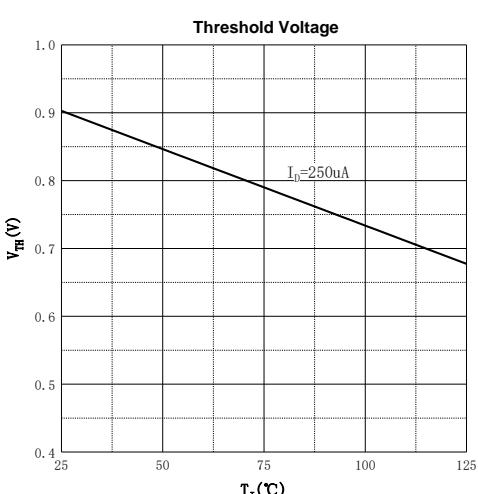
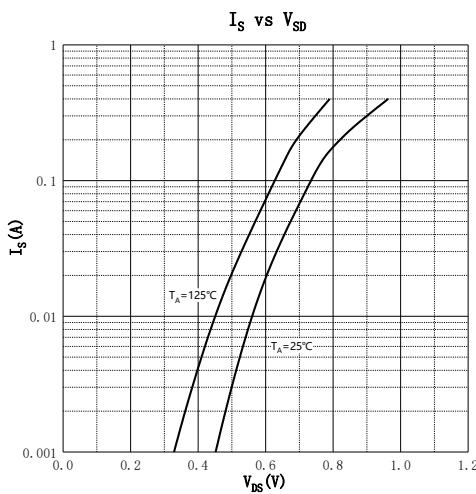
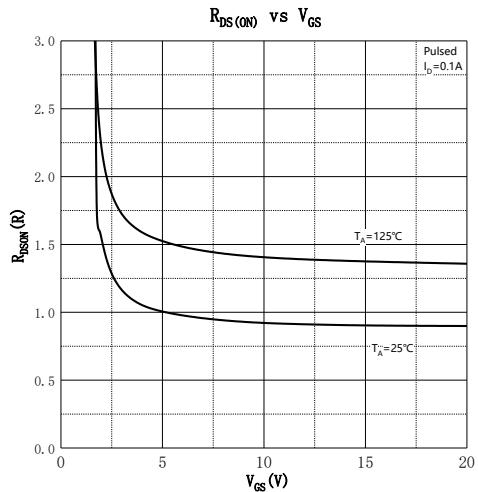
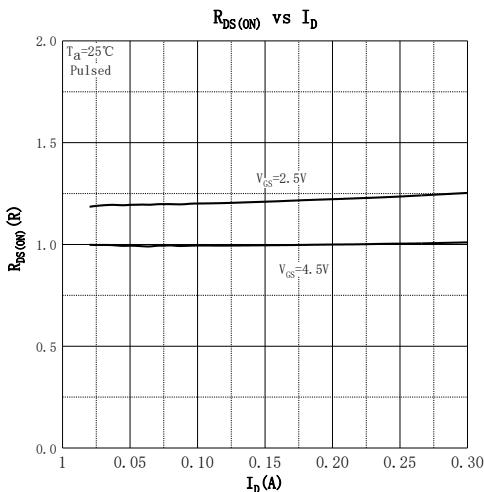
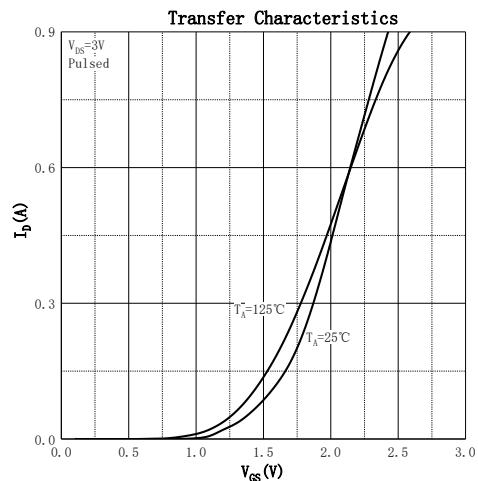
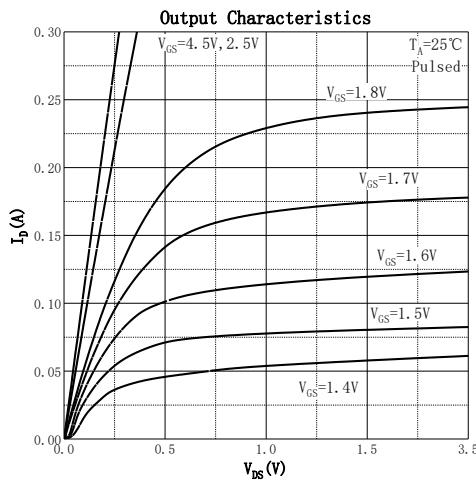
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

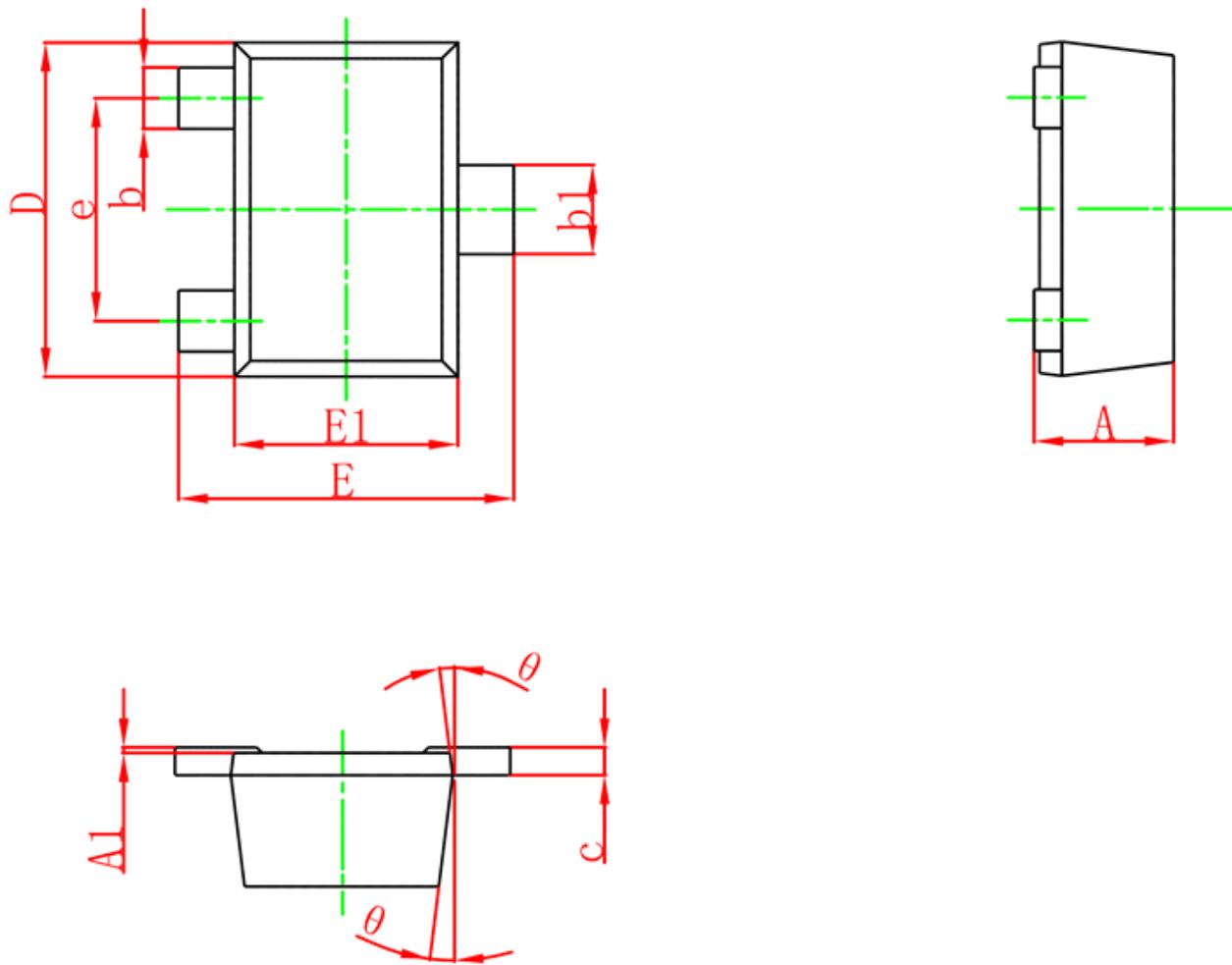
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			± 3	μA
On Characteristics³						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	0.5	0.9	1.5	V
Drain-source On-resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 0.4\text{A}$		0.92	2.5	Ω
		$V_{\text{GS}} = 4.5\text{V}, I_D = 0.2\text{A}$		0.98	3.0	
		$V_{\text{GS}} = 4.0\text{V}, I_D = 0.2\text{A}$		1.0	3.5	
		$V_{\text{GS}} = 2.5\text{V}, I_D = 0.1\text{A}$		1.2	4.5	
Forward Transconductance	g_{FS}	$V_{\text{DS}} = 4.5\text{V}, I_D = 3\text{A}$	3			S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 0.1\text{MHz}$		25		pF
Output Capacitance	C_{oss}			7		
Reverse Transfer Capacitance	C_{rss}			3		
Switching Characteristics						
Total Gate Charge	Q_g	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 0.3\text{A}$		2.1		nC
Gate-source Charge	Q_{gs}			0.42		
Gate-drain Charge	Q_{gd}			0.55		
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 15\text{V}, V_{\text{GS}} = 10\text{V}, R_L = 50\Omega, R_G = 3\Omega$		10.4		ns
Turn-on Rise Time	t_r			5		
Turn-off Delay Ttime	$t_{\text{d}(\text{off})}$			27		
Turn-off Fall Time	t_f			21		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = 0.3\text{A}$			1.2	V

Notes :

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$.
- 3.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 4.The power dissipation P_D is limited by $T_{J(\text{MAX})} = 150^\circ\text{C}$.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics



SOT-723 Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.340	0.500	0.013	0.020
A1	0.000	0.050	0.000	0.002
b	0.150	0.270	0.006	0.011
b1	0.200	0.370	0.008	0.015
c	0.060	0.160	0.002	0.006
D	1.100	1.300	0.043	0.051
E	1.100	1.300	0.043	0.051
E1	0.700	0.900	0.028	0.035
e	0.8TYP		0.031TYP	
θ	8°REF		8°REF	